

**AMENDMENTS TO THE SPECIFICATION**

**Please insert the following paragraph after the first full paragraph on page 12:**

The main surfaces of the substrate are a first and second surface, i.e., a top surface and a back (bottom) surface, which are opposite to each other. An end or edge surface (T) is formed along the thickness of the substrate. A chamfered surface (C) is formed on a perimeter edge region where the end (edge) surface and the top surface meet, and another chamfered surface is formed on another perimeter edge region where the end (edge) surface and the bottom surface meet.

**Please replace the paragraph bridging pages 16-17 with the following amended paragraph:**

Firstly, in order to clean substrates, photomask blanks and photomasks, (A) a so-called dip cleaning method involving the dipping of a substrate in a cleaning fluid or (B) a so-called spin cleaning method involving the rotation of a substrate while being supplied with a cleaning fluid may be employed. Besides these cleaning methods, (C) a so-called scrub cleaning method involving the scrubbing of the surface of a substrate with a cleaning tool such as sponge and brush may be employed. In the scrub cleaning method, the entire surface of the substrate is scrubbed while the substrate and/or the cleaning tool is being moved. However, since the cleaning tool comes in contact with the surface C, foreign matters potentially present on the surface C raise problems (see Fig. 4). Accordingly, by arranging the surface C so as to have a smaller surface roughness than the end surface T and to have less abraded grooves than the end surface T, the amount of particles to be generated from the surface C during scrub cleaning can be drastically reduced, making it possible to reduce the amount of particles to be generated from the side portion of the substrate.

**Please replace the second paragraph of page 17 with the following amended paragraph:**

In accordance with Embodiment 2, the end surface T is a roughened surface and, thus, ~~can be difficultly slipped~~ is less slippery and is completely handleable. Further, the end surface T comes in little contact with the cleaning tool (e.g., sponge, brush) during scrub cleaning, making it little likely that dust which can form particles can be discharged from the abraded grooves. Thus, the end surface T gives little or no serious problems even if it is a roughened surface.